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Docket 21MMC-10

## In the Specification

Please substitute the following paragraphs for the corresponding paragraphs being amended:

[0005] A major component of the cellular phone is the RF power amplifier thereof. Signal amplification require requires corresponding power that generates heat in the amplifier which must be suitably dissipated for protecting the amplifier and associated electronic components.

[0044] Figure 5 illustrates another exemplary cross section through the module illustrated in Figure 5 2 in which the printed circuits are vertically interconnected between the various metal layers 38 of the multiple PC boards by electrically conductive electrodes or terminals 40 extending vertically or transversely through the various substrates either internally therethrough or at the perimeter thereof as desired. These terminals may be formed by providing vertical holes or side notches in the substrates which are suitably lined with metal during the initial fabrication process.